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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	48MHz
Connectivity	UART/USART, USB
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	23
Program Memory Size	16KB (8K x 16)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	768 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf2450-i-so

PIC18F2450/4450

TABLE 1-3: PIC18F4450 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pi	n Numl	ber	Pin	Buffer	Description
Fill Name	PDIP	QFN	TQFP	Type	Type	Description
						PORTD is a bidirectional I/O port.
RD0	19	38	38	I/O	ST	Digital I/O.
RD1	20	39	39	I/O	ST	Digital I/O.
RD2	21	40	40	I/O	ST	Digital I/O.
RD3	22	41	41	I/O	ST	Digital I/O.
RD4	27	2	2	I/O	ST	Digital I/O.
RD5	28	3	3	I/O	ST	Digital I/O.
RD6	29	4	4	I/O	ST	Digital I/O.
RD7	30	5	5	I/O	ST	Digital I/O.

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

= Input

= Output = Power

Note 1: These pins are No Connect unless the ICPRT Configuration bit is set. For NC/ICPORTS, the pin is No Connect unless ICPRT is set and the DEBUG Configuration bit is cleared.

2.0 OSCILLATOR CONFIGURATIONS

2.1 Overview

Devices in the PIC18F2450/4450 family incorporate a different oscillator and microcontroller clock system than the non-USB PIC18F devices. The addition of the USB module, with its unique requirements for a stable clock source, make it necessary to provide a separate clock source that is compliant with both USB low-speed and full-speed specifications.

To accommodate these requirements, PIC18F2450/4450 devices include a new clock branch to provide a 48 MHz clock for full-speed USB operation. Since it is driven from the primary clock source, an additional system of prescalers and postscalers has been added to accommodate a wide range of oscillator frequencies. An overview of the oscillator structure is shown in Figure 2-1.

Other oscillator features used in PIC18 enhanced microcontrollers, such as the internal RC oscillator and clock switching, remain the same. They are discussed later in this chapter.

2.1.1 OSCILLATOR CONTROL

The operation of the oscillator in PIC18F2450/4450 devices is controlled through two Configuration registers and two control registers. Configuration registers, CONFIG1L and CONFIG1H, select the oscillator mode and USB prescaler/postscaler options. As Configuration bits, these are set when the device is programmed and left in that configuration until the device is reprogrammed.

The OSCCON register (Register 2-1) selects the Active Clock mode; it is primarily used in controlling clock switching in power-managed modes. Its use is discussed in **Section 2.4.1 "Oscillator Control Register"**.

2.2 Oscillator Types

PIC18F2450/4450 devices can be operated in twelve distinct oscillator modes. In contrast with the non-USB PIC18 enhanced microcontrollers, four of these modes involve the use of two oscillator types at once. Users can program the FOSC3:FOSC0 Configuration bits to select one of these modes:

1.	XT	Crystal/Resonator
2.	XTPLL	Crystal/Resonator with PLL Enabled
3.	HS	High-Speed Crystal/Resonator
4.	HSPLL	High-Speed Crystal/Resonator with PLL Enabled
5.	EC	External Clock with Fosc/4 Output
6.	ECIO	External Clock with I/O on RA6
7.	ECPLL	External Clock with PLL Enabled and Fosc/4 Output on RA6
8.	ECPIO	External Clock with PLL Enabled, I/O on RA6
9.	INTHS	Internal Oscillator used as Microcontroller Clock Source, HS Oscillator used as USB Clock Source
10.	INTXT	Internal Oscillator used as Microcontroller Clock Source, XT Oscillator used as USB Clock Source
11.	INTIO	Internal Oscillator used as Microcontroller Clock Source, EC Oscillator used as USB Clock Source, Digital I/O on RA6
12.	INTCKO	Internal Oscillator used as Microcontroller Clock Source, EC Oscillator used as USB Clock Source, Fosc/4 Output on RA6

3.5.4 EXIT WITHOUT AN OSCILLATOR START-UP DELAY

Certain exits from power-managed modes do not invoke the OST at all. There are two cases:

- PRI_IDLE mode, where the primary clock source is not stopped; and
- The primary clock source is not any of the XT or HS modes

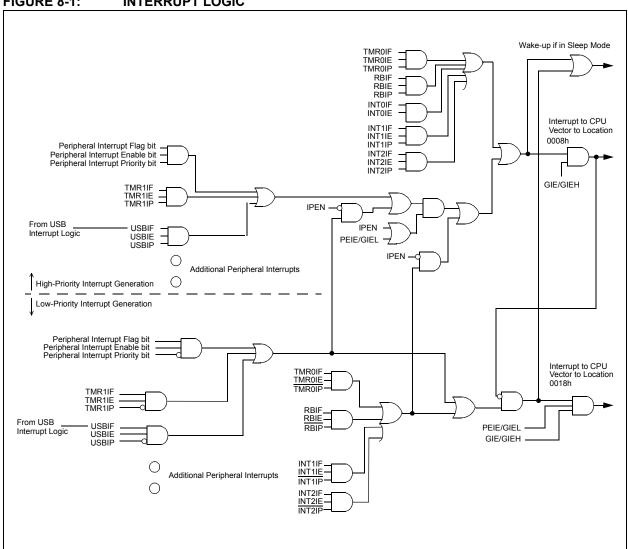
In these instances, the primary clock source either does not require an oscillator start-up delay, since it is already running (PRI_IDLE), or normally does not require an oscillator start-up delay (EC and any internal oscillator modes). However, a fixed delay of interval TCSD following the wake event is still required when leaving Sleep and Idle modes to allow the CPU to prepare for execution. Instruction execution resumes on the first clock cycle following this delay.

TABLE 3-2: EXIT DELAY ON WAKE-UP BY RESET FROM SLEEP MODE OR ANY IDLE MODE (BY CLOCK SOURCES)

Microcontroller	Clock Source	Evit Dalay	Clock Ready Status	
Before Wake-up	After Wake-up	Exit Delay	Bit (OSCCON)	
	XT, HS			
Primary Device Clock	XTPLL, HSPLL	None	OSTS	
(PRI_IDLE mode)	EC	INOTIC	0313	
	INTRC ⁽¹⁾			
	XT, HS	Tost ⁽³⁾		
T1OSC or INTRC ⁽¹⁾	XTPLL, HSPLL	Tost + t _{rc} (3)	OSTS	
TIOSC OF INTROV	EC	TCSD ⁽²⁾	0313	
	INTRC ⁽¹⁾	Tiobst ⁽⁴⁾]	
	XT, HS	Tost ⁽³⁾		
INTRC ⁽¹⁾	XTPLL, HSPLL	Tost + t _{rc} (3)	OSTS	
INTRO: 7	EC	TCSD ⁽²⁾	0313	
	INTRC ⁽¹⁾	None		
	XT, HS	Tost ⁽³⁾		
None	XTPLL, HSPLL	Tost + t _{rc} (3)	OSTS	
(Sleep mode)	EC	TCSD ⁽²⁾	0313	
	INTRC ⁽¹⁾	Tiobst ⁽⁴⁾		

- Note 1: In this instance, refers specifically to the 31 kHz INTRC clock source.
 - 2: TCSD (parameter 38, Table 21-10) is a required delay when waking from Sleep and all Idle modes and runs concurrently with any other required delays (see **Section 3.4 "Idle Modes"**).
 - 3: Tost is the Oscillator Start-up Timer period (parameter 32, Table 21-10). t_{rc} is the PLL lock time-out (parameter F12, Table 21-7); it is also designated as TPLL.
 - 4: Execution continues during TIOBST (parameter 39, Table 21-10), the INTRC stabilization period.

FIGURE 8-1: **INTERRUPT LOGIC**



8.3 PIR Registers

The PIR registers contain the individual flag bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are two Peripheral Interrupt Request (Flag) registers (PIR1 and PIR2).

- **Note 1:** Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the Global Interrupt Enable bit, GIE (INTCON<7>).
 - 2: User software should ensure the appropriate interrupt flag bits are cleared prior to enabling an interrupt and after servicing that interrupt.

REGISTER 8-4: PIR1: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 1

U-0	R/W-0	R-0	R-0	U-0	R/W-0	R/W-0	R/W-0
_	ADIF	RCIF	TXIF	_	CCP1IF	TMR2IF	TMR1IF
bit 7							bit 0

_	 _		_	١.
		n		

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6 ADIF: A/D Converter Interrupt Flag bit

1 = An A/D conversion completed (must be cleared in software)

0 = The A/D conversion is not complete

bit 5 RCIF: EUSART Receive Interrupt Flag bit

1 = The EUSART receive buffer, RCREG, is full (cleared when RCREG is read)

0 = The EUSART receive buffer is empty

bit 4 TXIF: EUSART Transmit Interrupt Flag bit

1 = The EUSART transmit buffer, TXREG, is empty (cleared when TXREG is written)

0 = The EUSART transmit buffer is full

bit 3 Unimplemented: Read as '0'

bit 2 CCP1IF: CCP1 Interrupt Flag bit

Capture mode:

1 = A TMR1 register capture occurred (must be cleared in software)

0 = No TMR1 register capture occurred

Compare mode:

1 = A TMR1 register compare match occurred (must be cleared in software)

0 = No TMR1 register compare match occurred

PWM mode:

Unused in this mode.

bit 1 TMR2IF: TMR2 to PR2 Match Interrupt Flag bit

1 = TMR2 to PR2 match occurred (must be cleared in software)

0 = No TMR2 to PR2 match occurred

bit 0 TMR1IF: TMR1 Overflow Interrupt Flag bit

1 = TMR1 register overflowed (must be cleared in software)

0 = TMR1 register did not overflow

8.4 PIE Registers

Legend:

R = Readable bit

The PIE registers contain the individual enable bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are two Peripheral Interrupt Enable registers (PIE1 and PIE2). When IPEN = 0, the PEIE bit must be set to enable any of these peripheral interrupts.

REGISTER 8-6: PIE1: PERIPHERAL INTERRUPT ENABLE REGISTER 1

W = Writable bit

U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
_	ADIE	RCIE	TXIE	_	CCP1IE	TMR2IE	TMR1IE
bit 7							bit 0

U = Unimplemented bit, read as '0'

x = Bit is unknown

-n = Value at Po	OR '1' = Bit is set	'0' = Bit is cleared
bit 7	Unimplemented: Read as '0'	
bit 6	ADIE: A/D Converter Interrupt Enable bit	
	1 = Enables the A/D interrupt	
	0 = Disables the A/D interrupt	
bit 5	RCIE: EUSART Receive Interrupt Enable	bit
	1 = Enables the EUSART receive interrup	
	0 = Disables the EUSART receive interrup	ot
bit 4	TXIE: EUSART Transmit Interrupt Enable	bit
	1 = Enables the EUSART transmit interru	pt
	0 = Disables the EUSART transmit interru	ıpt
bit 3	Unimplemented: Read as '0'	
bit 2	CCP1IE: CCP1 Interrupt Enable bit	
	1 = Enables the CCP1 interrupt	
	0 = Disables the CCP1 interrupt	
bit 1	TMR2IE: TMR2 to PR2 Match Interrupt Er	nable bit
	$_{1}$ = Enables the TMR2 to PR2 match inter	•
	0 = Disables the TMR2 to PR2 match inte	rrupt
bit 0	TMR1IE: TMR1 Overflow Interrupt Enable	bit
	$_{1}$ = Enables the TMR1 overflow interrupt	
	0 = Disables the TMR1 overflow interrupt	

8.7 INTx Pin Interrupts

External interrupts on the RB0/AN12/INT0, RB1/AN10/INT1and RB2/AN8/INT2/VMO pins are edge-triggered. If the corresponding INTEDGx bit in the INTCON2 register is set (= 1), the interrupt is triggered by a rising edge; if the bit is clear, the trigger is on the falling edge. When a valid edge appears on the RBx/INTx pin, the corresponding flag bit, INTxIF, is set. This interrupt can be disabled by clearing the corresponding enable bit, INTxIE. Flag bit, INTxIF, must be cleared in software in the Interrupt Service Routine before re-enabling the interrupt.

All external interrupts (INT0, INT1 and INT2) can wakeup the processor from the power-managed modes if bit, INTxIE, was set prior to going into the power-managed modes. If the Global Interrupt Enable bit, GIE, is set, the processor will branch to the interrupt vector following wake-up.

Interrupt priority for INT1 and INT2 is determined by the value contained in the interrupt priority bits, INT1IP (INTCON3<6>) and INT2IP (INTCON3<7>). There is no priority bit associated with INT0. It is always a high-priority interrupt source.

8.8 TMR0 Interrupt

In 8-bit mode (which is the default), an overflow in the TMR0 register (FFh \rightarrow 00h) will set flag bit, TMR0IF. In 16-bit mode, an overflow in the TMR0H:TMR0L register pair (FFFFh \rightarrow 0000h) will set TMR0IF. The interrupt can be enabled/disabled by setting/clearing enable bit, TMR0IE (INTCON<5>). Interrupt priority for Timer0 is determined by the value contained in the interrupt priority bit, TMR0IP (INTCON2<2>). See Section 12.0 "Timer2 Module" for further details on the Timer0 module.

8.9 PORTB Interrupt-on-Change

An input change on PORTB<7:4> sets flag bit, RBIF (INTCON<0>). The interrupt can be enabled/disabled by setting/clearing enable bit, RBIE (INTCON<3>). Interrupt priority for PORTB interrupt-on-change is determined by the value contained in the interrupt priority bit, RBIP (INTCON2<0>).

8.10 Context Saving During Interrupts

During interrupts, the return PC address is saved on the stack. Additionally, the WREG, STATUS and BSR registers are saved on the Fast Return Stack. If a fast return from interrupt is not used (see **Section 5.3** "**Data Memory Organization**"), the user may need to save the WREG, STATUS and BSR registers on entry to the Interrupt Service Routine. Depending on the user's application, other registers may also need to be saved. Example 8-1 saves and restores the WREG, STATUS and BSR registers during an Interrupt Service Routine.

EXAMPLE 8-1: SAVING STATUS. WREG AND BSR REGISTERS IN RAM

```
MOVWF
       W TEMP
                                     ; W TEMP is in virtual bank
MOVFF
       STATUS, STATUS TEMP
                                     ; STATUS TEMP located anywhere
MOVFF
       BSR, BSR_TEMP
                                     ; BSR TMEP located anywhere
:
; USER ISR CODE
MOVEF
       BSR TEMP, BSR
                                     ; Restore BSR
       W TEMP, W
MOVF
                                     ; Restore WREG
       STATUS TEMP, STATUS
MOVEF
                                     ; Restore STATUS
```

14.5.2 **USB INTERRUPT ENABLE** REGISTER (UIE)

Legend:

R = Readable bit

The USB Interrupt Enable register (Register 14-8) contains the enable bits for the USB status interrupt sources. Setting any of these bits will enable the respective interrupt source in the UIR register.

The values in this register only affect the propagation of an interrupt condition to the microcontroller's interrupt logic. The flag bits are still set by their interrupt conditions, allowing them to be polled and serviced without actually generating an interrupt.

x = Bit is unknown

U = Unimplemented bit, read as '0'

REGISTER 14-8: UIE: USB INTERRUPT ENABLE REGISTER

W = Writable bit

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	SOFIE	STALLIE	IDLEIE	TRNIE	ACTVIE	UERRIE	URSTIE
bit 7							bit 0

-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared
bit 7 Un	implemented: Read as '0'	
bit 6 SO	FIE: Start-of-Frame Token Interrupt E	nable bit
	Start-of-Frame token interrupt enable Start-of-Frame token interrupt disable	
bit 5 ST	ALLIE: STALL Handshake Interrupt E	nable bit
	STALL interrupt enabled	
0 =	STALL interrupt disabled	
bit 4 IDI	.EIE: Idle Detect Interrupt Enable bit	
	Idle detect interrupt enabled Idle detect interrupt disabled	
bit 3 TR	NIE: Transaction Complete Interrupt E	nable bit
	Transaction interrupt enabled Transaction interrupt disabled	
bit 2 AC	TVIE: Bus Activity Detect Interrupt En	able bit
1 =	Bus activity detect interrupt enabled	
0 =	Bus activity detect interrupt disabled	
bit 1 UE	RRIE: USB Error Interrupt Enable bit	
	USB error interrupt enabled	
	USB error interrupt disabled	
bit 0 UR	STIE: USB Reset Interrupt Enable bit	
	USB Reset interrupt enabled	
0 =	USB Reset interrupt disabled	

TABLE 15-3: BAUD RATES FOR ASYNCHRONOUS MODES (CONTINUED)

		SYNC = 0, BRGH = 0, BRG16 = 1												
BAUD RATE	Fosc	= 40.000) MHz	Fosc	= 20.000) MHz	Fosc = 10.000 MHz			Fosc = 8.000 MHz				
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)		
0.3	0.300	0.00	8332	0.300	0.02	4165	0.300	0.02	2082	0.300	-0.04	1665		
1.2	1.200	0.02	2082	1.200	-0.03	1041	1.200	-0.03	520	1.201	-0.16	415		
2.4	2.402	0.06	1040	2.399	-0.03	520	2.404	0.16	259	2.403	-0.16	207		
9.6	9.615	0.16	259	9.615	0.16	129	9.615	0.16	64	9.615	-0.16	51		
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19.230	-0.16	25		
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55.555	3.55	8		
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4		_	_		

			s	YNC = 0, E	BRGH = 0	, BRG16 =	1			
BAUD	Fosc	c = 4.000	MHz	Fos	c = 2.000	MHz	Fos	Fosc = 1.000 MHz		
RATE (K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	
0.3	0.300	0.04	832	0.300	-0.16	415	0.300	-0.16	207	
1.2	1.202	0.16	207	1.201	-0.16	103	1.201	-0.16	51	
2.4	2.404	0.16	103	2.403	-0.16	51	2.403	-0.16	25	
9.6	9.615	0.16	25	9.615	-0.16	12	_	_	_	
19.2	19.231	0.16	12	_	_	_	_	_	_	
57.6	62.500	8.51	3	_	_	_	_	_	_	
115.2	125.000	8.51	1	_	_	_	_	_	_	

	SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1												
BAUD	Fosc = 40.000 MHz			Fosc	Fosc = 20.000 MHz		Fosc	Fosc = 10.000 MHz			Fosc = 8.000 MHz		
RATE (K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	
0.3	0.300	0.00	33332	0.300	0.00	16665	0.300	0.00	8332	0.300	-0.01	6665	
1.2	1.200	0.00	8332	1.200	0.02	4165	1.200	0.02	2082	1.200	-0.04	1665	
2.4	2.400	0.02	4165	2.400	0.02	2082	2.402	0.06	1040	2.400	-0.04	832	
9.6	9.606	0.06	1040	9.596	-0.03	520	9.615	0.16	259	9.615	-0.16	207	
19.2	19.193	-0.03	520	19.231	0.16	259	19.231	0.16	129	19.230	-0.16	103	
57.6	57.803	0.35	172	57.471	-0.22	86	58.140	0.94	42	57.142	0.79	34	
115.2	114.943	-0.22	86	116.279	0.94	42	113.636	-1.36	21	117.647	-2.12	16	

	SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1									
BAUD RATE	Fosc = 4.000 MHz			Fosc = 2.000 MHz			Fosc = 1.000 MHz			
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	
0.3	0.300	0.01	3332	0.300	-0.04	1665	0.300	-0.04	832	
1.2	1.200	0.04	832	1.201	-0.16	415	1.201	-0.16	207	
2.4	2.404	0.16	415	2.403	-0.16	207	2.403	-0.16	103	
9.6	9.615	0.16	103	9.615	-0.16	51	9.615	-0.16	25	
19.2	19.231	0.16	51	19.230	-0.16	25	19.230	-0.16	12	
57.6	58.824	2.12	16	55.555	3.55	8	_	_	_	
115.2	111.111	-3.55	8	_	_	_	_	_	_	

16.1 A/D Acquisition Requirements

For the A/D Converter to meet its specified accuracy, the charge holding capacitor (Chold) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 16-3. The source impedance (Rs) and the internal sampling switch (Rss) impedance directly affect the time required to charge the capacitor Chold. The sampling switch (Rss) impedance varies over the device voltage (VDD). The source impedance affects the offset voltage at the analog input (due to pin leakage current). The maximum recommended impedance for analog sources is 2.5 k Ω . After the analog input channel is selected (changed), the channel must be sampled for at least the minimum acquisition time before starting a conversion.

Note: When the conversion is started, the

holding capacitor is disconnected from the input pin.

To calculate the minimum acquisition time, Equation 16-1 may be used. This equation assumes that 1/2 LSb error is used (1024 steps for the A/D). The 1/2 LSb error is the maximum error allowed for the A/D to meet its specified resolution.

Example 16-3 shows the calculation of the minimum required acquisition time TACQ. This calculation is based on the following application system assumptions:

CHOLD = 25 pF Rs = 2.5 kΩ Conversion Error \leq 1/2 LSb

VDD = $5V \rightarrow Rss = 2 \text{ k}\Omega$ Temperature = 85°C (system max.)

EQUATION 16-1: ACQUISITION TIME

```
TACQ = Amplifier Settling Time + Holding Capacitor Charging Time + Temperature Coefficient
= TAMP + TC + TCOFF
```

EQUATION 16-2: A/D MINIMUM CHARGING TIME

```
VHOLD = (VREF - (VREF/2048)) \cdot (1 - e^{(-TC/CHOLD(RIC + RSS + RS))})

or

TC = -(CHOLD)(RIC + RSS + RS) \ln(1/2048)
```

EQUATION 16-3: CALCULATING THE MINIMUM REQUIRED ACQUISITION TIME

```
TACQ
                     TAMP + TC + TCOFF
TAMP
                     0.2 \,\mu s
TCOFF
                     (Temp - 25^{\circ}C)(0.02 \mu s/^{\circ}C)
                     (85^{\circ}C - 25^{\circ}C)(0.02 \,\mu\text{s/}^{\circ}C)
                     1.2 us
Temperature coefficient is only required for temperatures > 25°C. Below 25°C, TCOFF = 0 ms.
TC
                     -(CHOLD)(RIC + RSS + RS) ln(1/2047) \mu s
                     -(25 \text{ pF}) (1 \text{ k}\Omega + 2 \text{ k}\Omega + 2.5 \text{ k}\Omega) \ln(0.0004883) \,\mu\text{s}
                     1.05 \mu s
                     0.2 \mu s + 1 \mu s + 1.2 \mu s
TACO
                     2.4 \mu s
```

18.0 SPECIAL FEATURES OF THE CPU

PIC18F2450/4450 devices include several features intended to maximize reliability and minimize cost through elimination of external components. These are:

- · Oscillator Selection
- · Resets:
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
 - Brown-out Reset (BOR)
- Interrupts
- Watchdog Timer (WDT)
- · Fail-Safe Clock Monitor (FSCM)
- · Two-Speed Start-up
- · Code Protection
- · ID Locations
- In-Circuit Serial Programming (ICSP)

The oscillator can be configured for the application depending on frequency, power, accuracy and cost. All of the options are discussed in detail in **Section 2.0** "Oscillator Configurations".

A complete discussion of device Resets and interrupts is available in previous sections of this data sheet.

In addition to their Power-up and Oscillator Start-up Timers provided for Resets, PIC18F2450/4450 devices have a Watchdog Timer, which is either permanently enabled via the Configuration bits or software controlled (if configured as disabled).

The inclusion of an internal RC oscillator also provides the additional benefits of a Fail-Safe Clock Monitor (FSCM) and Two-Speed Start-up. FSCM provides for background monitoring of the peripheral clock and automatic switchover in the event of its failure. Two-Speed Start-up enables code to be executed almost immediately on start-up, while the primary clock source completes its start-up delays.

All of these features are enabled and configured by setting the appropriate Configuration register bits.

REGISTER 18-15: WDTCON: WATCHDOG TIMER CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
_	_	_	_	_	_	_	SWDTEN ⁽¹⁾
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-1 **Unimplemented:** Read as '0'

bit 0 **SWDTEN:** Software Controlled Watchdog Timer Enable bit⁽¹⁾

1 = Watchdog Timer is on0 = Watchdog Timer is off

Note 1: This bit has no effect if the Configuration bit, WDTEN, is enabled.

TABLE 18-2: SUMMARY OF WATCHDOG TIMER REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
RCON	IPEN	SBOREN ⁽¹⁾	_	RI	TO	PD	POR	BOR	50
WDTCON	_	_	_	_	_	_	_	SWDTEN	50

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Watchdog Timer.

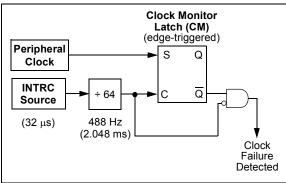
Note 1: The SBOREN bit is only available when BOREN<1:0> = 01; otherwise, the bit reads as '0'.

18.4 Fail-Safe Clock Monitor

The Fail-Safe Clock Monitor (FSCM) allows the microcontroller to continue operation in the event of an external oscillator failure by automatically switching the device clock to the internal oscillator. The FSCM function is enabled by setting the FCMEN Configuration bit.

When FSCM is enabled, the INTRC oscillator runs at all times to monitor clocks to peripherals and provide a backup clock in the event of a clock failure. Clock monitoring (shown in Figure 18-3) is accomplished by creating a sample clock signal, which is the INTRC output divided by 64. This allows ample time between FSCM sample clocks for a peripheral clock edge to occur. The peripheral device clock and the sample clock are presented as inputs to the Clock Monitor latch (CM). The CM is set on the falling edge of the device clock source, but cleared on the rising edge of the sample clock.

FIGURE 18-3: FSCM BLOCK DIAGRAM



Clock failure is tested for on the falling edge of the sample clock. If a sample clock falling edge occurs while CM is still set, a clock failure has been detected (Figure 18-4). This causes the following:

- the FSCM generates an oscillator fail interrupt by setting bit, OSCFIF (PIR2<7>);
- the device clock source is switched to the internal oscillator (OSCCON is not updated to show the current clock source – this is the fail-safe condition); and
- · the WDT is reset.

The FSCM will detect failures of the primary or secondary clock sources only. If the internal oscillator fails, no failure would be detected, nor would any action be possible.

18.4.1 FSCM AND THE WATCHDOG TIMER

Both the FSCM and the WDT are clocked by the INTRC oscillator. Since the WDT operates with a separate divider and counter, disabling the WDT has no effect on the operation of the INTRC oscillator when the FSCM is enabled.

If the WDT is enabled with a small prescale value, a decrease in clock speed allows a WDT time-out to occur and a subsequent device Reset. For this reason, Fail-Safe Clock Monitor events also reset the WDT and postscaler, allowing it to start timing from when execution speed was changed and decreasing the likelihood of an erroneous time-out.

18.4.2 EXITING FAIL-SAFE OPERATION

The fail-safe condition is terminated by either a device Reset or by entering a power-managed mode. On Reset, the controller starts the primary clock source specified in Configuration Register 1H (with any start-up delays that are required for the oscillator mode, such as OST or PLL timer). The INTRC provides the device clock until the primary clock source becomes ready (similar to a Two-Speed Start-up). The clock source is then switched to the primary clock (indicated by the OSTS bit in the OSCCON register becoming set). The Fail-Safe Clock Monitor then resumes monitoring the peripheral clock.

The primary clock source may never become ready during start-up. In this case, operation is clocked by the INTRC. The OSCCON register will remain in its Reset state until a power-managed mode is entered.

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TABLE 19-1: OPCODE FIELD DESCRIPTIONS

Field	Description
a	RAM access bit
	a = 0: RAM location in Access RAM (BSR register is ignored)
	a = 1: RAM bank is specified by BSR register
bbb	Bit address within an 8-bit file register (0 to 7).
BSR	Bank Select Register. Used to select the current RAM bank.
C, DC, Z, OV, N	ALU Status bits: Carry, Digit Carry, Zero, Overflow, Negative.
d	Destination select bit
	d = 0: store result in WREG d = 1: store result in file register f
dest	Destination: either the WREG register or the specified register file location.
f	8-bit register file address (00h to FFh) or 2-bit FSR designator (0h to 3h).
fs	12-bit register file address (000h to FFFh). This is the source address.
f _d	12-bit register file address (000h to FFFh). This is the destination address.
GIE	Global Interrupt Enable bit.
k	Literal field, constant data or label (may be either an 8-bit, 12-bit or a 20-bit value).
label	Label name.
	The mode of the TBLPTR register for the table read and table write instructions.
mm	Only used with table read and table write instructions:
*	No change to register (such as TBLPTR with table reads and writes)
*+	Post-Increment register (such as TBLPTR with table reads and writes)
*_	Post-Decrement register (such as TBLPTR with table reads and writes)
+*	Pre-Increment register (such as TBLPTR with table reads and writes)
n	The relative address (2's complement number) for relative branch instructions or the direct address for
11	Call/Branch and Return instructions.
PC	Program Counter.
PCL	Program Counter Low Byte.
PCH	Program Counter High Byte.
PCLATH	Program Counter High Byte Latch.
PCLATU	Program Counter Upper Byte Latch.
PD	Power-Down bit.
PRODH	Product of Multiply High Byte.
PRODL	Product of Multiply Low Byte.
S	Fast Call/Return mode select bit
	s = 0: do not update into/from shadow registers
	s = 1: certain registers loaded into/from shadow registers (Fast mode)
TBLPTR	21-bit Table Pointer (points to a program memory location).
TABLAT	8-bit Table Latch.
TO	Time-out bit.
TOS	Top-of-Stack.
u	Unused or unchanged.
WDT	Watchdog Timer.
WREG	Working register (accumulator).
х	Don't care ('0' or '1'). The assembler will generate code with $x = 0$. It is the recommended form of use for
	compatibility with all Microchip software tools.
Z _S	7-bit offset value for indirect addressing of register files (source).
z _d	7-bit offset value for indirect addressing of register files (destination).
{ }	Optional argument.
[text]	Indicates an indexed address.
(text)	The contents of text.
[expr] <n></n>	Specifies bit n of the register indicated by the pointer, expr.
\rightarrow	Assigned to.
< >	Register bit field.
€	In the set of.
italics	User-defined term (font is Courier New).

TABLE 19-2: PIC18FXXXX INSTRUCTION SET (CONTINUED)

Mnemo	onic,	Description	Cycles	16-	Bit Instr	uction V	Vord	Status	Notes
Opera	nds	Description	Cycles	MSb		LSb		Affected	Notes
BIT-ORIEN	ITED OP	ERATIONS							
BCF	f, b, a	Bit Clear f	1	1001	bbba	ffff	ffff	None	1, 2
BSF	f, b, a	Bit Set f	1	1000	bbba	ffff	ffff	None	1, 2
BTFSC	f, b, a	Bit Test f, Skip if Clear	1 (2 or 3)	1011	bbba	ffff	ffff	None	3, 4
BTFSS	f, b, a	Bit Test f, Skip if Set	1 (2 or 3)	1010	bbba	ffff	ffff	None	3, 4
BTG	f, d, a	Bit Toggle f	1	0111	bbba	ffff	ffff	None	1, 2
CONTROL	OPERA	TIONS	•						1
ВС	n	Branch if Carry	1 (2)	1110	0010	nnnn	nnnn	None	
BN	n	Branch if Negative	1 (2)	1110	0110	nnnn	nnnn	None	
BNC	n	Branch if Not Carry	1 (2)	1110	0011	nnnn	nnnn	None	
BNN	n	Branch if Not Negative	1 (2)	1110	0111	nnnn	nnnn	None	
BNOV	n	Branch if Not Overflow	1 (2)	1110	0101	nnnn	nnnn	None	
BNZ	n	Branch if Not Zero	1 (2)	1110	0001	nnnn	nnnn	None	
BOV	n	Branch if Overflow	1 (2)	1110	0100	nnnn	nnnn	None	
BRA	n	Branch Unconditionally	2	1101	0nnn	nnnn	nnnn	None	
BZ	n	Branch if Zero	1 (2)	1110	0000	nnnn	nnnn	None	
CALL	n, s	Call Subroutine 1st word	2	1110	110s	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
CLRWDT	_	Clear Watchdog Timer	1	0000	0000	0000	0100	TO, PD	
DAW	_	Decimal Adjust Wreg	1	0000	0000	0000	0111	С	
GOTO	n	Go To Address 1st word	2	1110	1111	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
NOP	_	No Operation	1	0000	0000	0000	0000	None	
NOP	_	No Operation	1	1111	XXXX	XXXX	XXXX	None	4
POP	_	Pop Top of Return Stack (TOS)	1	0000	0000	0000	0110	None	
PUSH	_	Push Top of Return Stack (TOS)	1	0000	0000	0000	0101	None	
RCALL	n	Relative Call	2	1101	1nnn	nnnn	nnnn	None	
RESET		Software Device Reset	1	0000	0000	1111	1111	All	
RETFIE	S	Return from Interrupt Enable	2	0000	0000	0001	000s	GIE/GIEH,	
	_							PEIE/GIEL	
RETLW	k	Return with Literal in WREG	2	0000	1100	kkkk	kkkk	None	
RETURN	S	Return from Subroutine	2	0000	0000	0001	001s	None	
SLEEP	_	Go into Standby mode	1	0000	0000	0000	0011	TO, PD	

Note 1: When a PORT register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as an input and is driven low by an external device, the data will be written back with a '0'.

^{2:} If this instruction is executed on the TMR0 register (and where applicable, 'd' = 1), the prescaler will be cleared if assigned.

^{3:} If the Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

^{4:} Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

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SLEEP	Enter Sle	Enter Sleep Mode					
Syntax:	SLEEP	SLEEP					
Operands:	None	None					
Operation:							
Status Affected:	$\overline{TO}, \overline{PD}$						
Encoding:	0000	0000	0000	0011			
Description:	The Power-Down status bit (PD) is cleared. The Time-out status bit (TO)						

is set. Watchdog Timer and its postscaler are cleared.

The processor is put into Sleep mode

with the oscillator stopped.

Words: Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No	Process	Go to
	operation	Data	Sleep

Example: SLEEP Before Instruction <u>TO</u> = PD = After Instruction TO =

† If WDT causes wake-up, this bit is cleared.

SUB	FWB	Sı	Subtract f from W with Borrow						
Synta	ax:	S	UBFWB	f {,d {,a	a}}				
Oper	ands:	d	≤ f ≤ 255 ∈ [0,1] ∈ [0,1]	i					
Oper	ation:	(V	/) – (f) –	$(\overline{C}) \rightarrow de$	est				
Status Affected:			N, OV, C, DC, Z						
Enco	ding:		0101	01da	fff	f	ffff		
Description: Subtract register 'f' and Carry flag (borrow) from W (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is use to select the GPR bank (default). If 'a' is '0' and the extended instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 19.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.						ment is stored stored in s is used ult). Istruction in ffset			
Word	ls:	1	000 101	dotano.					
Cycle	es:	1							
•	ycle Activity:								
	Q1	(Q2	Q3			Q4		
	Decode		ead ster 'f'	Proces Data			/rite to stination		
Exan	nple 1:	SU	JBFWB	REG,	1, 0				
	Before Instruction REG W C After Instruction REG W C Z	= = on = = = =	3 2 1 FF 2 0						
Evan	N anlo 2:	=	, -	sult is ne	J	9			
⊏xan	<u>nple 2:</u> Before Instruc		JBFWB	REG,	U, U				
	REG W C After Instruction	= = =	2 5 1						
	REG W C	= = =	2 3 1						

; result is positive

; result is zero

REG, 1, 0

SUBFWB

1 2 0

0 2 1

Example 3:

Before Instruction REG

W

After Instruction

REG =

W =

C =

Z =

N =

CALLW Subroutine Call Using WREG

Syntax: **CALLW**

Operands: None

 $(PC + 2) \rightarrow TOS$, Operation: $(W) \rightarrow PCL$

 $(PCLATH) \rightarrow PCH,$ (PCLATU) → PCU

Status Affected: None

Encoding: 0000

Description First, the return address (PC + 2) is

> pushed onto the return stack. Next, the contents of W are written to PCL; the existing value is discarded. Then the contents of PCLATH and PCLATU are

0001

0100

0000

latched into PCH and PCU, respectively. The second cycle is executed as a NOP instruction while the new next instruction is fetched. Unlike CALL, there is no option to

update W, STATUS or BSR.

Words: 1 2 Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Push PC to	No
	WREG	stack	operation
No	No	No	No
operation	operation	operation	operation

Example: HERE CALLW

Before Instruction

PC address (HERE)

PCLATH = 10h PCLATU W 00h 06h

After Instruction

001006h PC

TOS address (HERE + 2)

PCLATH = 10h PCLATU = 00h06h

MOVSF Move Indexed to f

 $\overline{\text{MOVSF}}$ [z_s], f_d Syntax: $0 \le z_s \le 127$ Operands: $0 \leq f_d \leq 4095$

 $((FSR2) + z_s) \rightarrow f_d$ Operation:

Status Affected: None

Encoding: 1st word (source)

1110 2nd word (destin.) 1111

ffff ffff $ffff_d$ Description: The contents of the source register are

1011

moved to destination register 'f_d'. The actual address of the source register is determined by adding the 7-bit literal offset 'zs' in the first word to the value of FSR2. The address of the destination register is specified by the 12-bit literal 'f_d' in the second word. Both addresses can be anywhere in the 4096-byte data

0zzz

ZZZZs

space (000h to FFFh).

The MOVSF instruction cannot use the PCL, TOSU, TOSH or TOSL as the

destination register.

If the resultant source address points to an indirect addressing register, the

value returned will be 00h.

Words: 2 Cycles: 2

Q Cycle Activity:

Q1 Q2 Q3 Q4 Decode Determine Determine Read source addr source addr source reg Decode Write No No operation operation register 'f' (dest) No dummy read

Example: [05h], REG2 MOVSF

Before Instruction

80h FSR2 = Contents of 85h 33h REG2 11h

After Instruction

FSR2 80h Contents 33h of 85h RFG2 33h

20.11 PICSTART Plus Development Programmer

The PICSTART Plus Development Programmer is an easy-to-use, low-cost, prototype programmer. It connects to the PC via a COM (RS-232) port. MPLAB Integrated Development Environment software makes using the programmer simple and efficient. The PICSTART Plus Development Programmer supports most PIC devices in DIP packages up to 40 pins. Larger pin count devices, such as the PIC16C92X and PIC17C76X, may be supported with an adapter socket. The PICSTART Plus Development Programmer is CE compliant.

20.12 PICkit 2 Development Programmer

The PICkit™ 2 Development Programmer is a low-cost programmer and selected Flash device debugger with an easy-to-use interface for programming many of Microchip's baseline, mid-range and PIC18F families of Flash memory microcontrollers. The PICkit 2 Starter Kit includes a prototyping development board, twelve sequential lessons, software and HI-TECH's PICC™ Lite C compiler, and is designed to help get up to speed quickly using PIC® microcontrollers. The kit provides everything needed to program, evaluate and develop applications using Microchip's powerful, mid-range Flash memory family of microcontrollers.

20.13 Demonstration, Development and Evaluation Boards

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

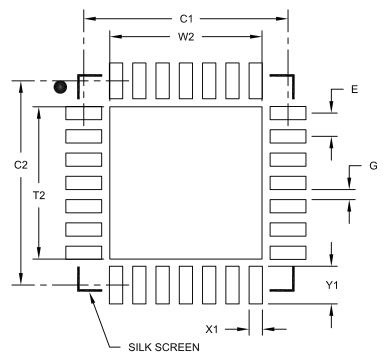
The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM™ and dsPICDEM™ demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, Keeloq® security ICs, CAN, IrDA®, PowerSmart battery management, SEEVAL® evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension	MIN	NOM	MAX	
Contact Pitch	Е		0.65 BSC	
Optional Center Pad Width	W2			4.25
Optional Center Pad Length	T2			4.25
Contact Pad Spacing	C1		5.70	
Contact Pad Spacing	C2		5.70	
Contact Pad Width (X28)	X1			0.37
Contact Pad Length (X28)	Y1			1.00
Distance Between Pads	G	0.20		

Notes:

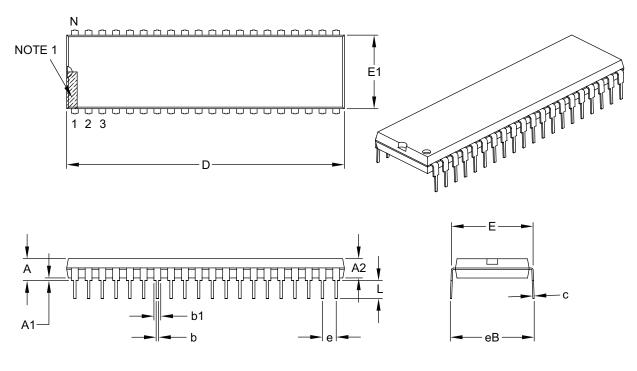
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2105A

40-Lead Plastic Dual In-Line (P) - 600 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units			INCHES			
	Dimension Limits	MIN	NOM	MAX			
Number of Pins	N		40				
Pitch	е		.100 BSC				
Top to Seating Plane	A	_	_	.250			
Molded Package Thickness	A2	.125	_	.195			
Base to Seating Plane	A1	.015	_	_			
Shoulder to Shoulder Width	E	.590	_	.625			
Molded Package Width	E1	.485	_	.580			
Overall Length	D	1.980	_	2.095			
Tip to Seating Plane	L	.115	_	.200			
Lead Thickness	С	.008	_	.015			
Upper Lead Width	b1	.030	_	.070			
Lower Lead Width	b	.014	_	.023			
Overall Row Spacing §	eB	_	_	.700			

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-016B